



HOSTAFORM®

Hostaform® acetal copolymer grade S 9364 WS 10/1570 is a highly impact modified grade for demanding applications that also need improved resistance to UV exposure. Besides weatherability, Hostaform® S 9364 WS 10/1570 provides a significant improvement in impact strength and flexibility over standard impact modified grades. This grade is only available in black. Chemical abbreviation according to ISO 1043-1: POM-HI

Product information

Resin Identification Part Marking Code	POM-I >POM-I<		ISO 1043 ISO 11469
Rheological properties			
Melt volume-flow rate Temperature Load	4.5 190 2.16		ISO 1133
Typical mechanical properties			
Tensile modulus Tensile stress at yield, 50mm/min Tensile strain at yield, 50mm/min Flexural modulus Flexural stress at 3.5% Charpy notched impact strength, 23°C Charpy notched impact strength, -30°C Poisson's ratio [C]: Calculated	20 1400 37 16	MPa %	ISO 527-1/-2 ISO 527-1/-2 ISO 527-1/-2 ISO 178 ISO 178 ISO 179/1eA ISO 179/1eA
Thermal properties			
Melting temperature, 10 °C/min Temperature of deflection under load, 1.8 MPa Coefficient of linear thermal expansion (CLTE), parallel Coefficient of linear thermal expansion (CLTE), normal	120	°C °C E-6/K	ISO 11357-1/-3 ISO 75-1/-2 ISO 11359-1/-2 ISO 11359-1/-2
Physical/Other properties			
Humidity absorption, 2mm Water absorption, 2mm Density	0.25 0.8 1370		Sim. to ISO 62 Sim. to ISO 62 ISO 1183
Injection			
Drying Recommended Drying Temperature Drying Time, Dehumidified Dryer Processing Moisture Content Melt Temperature Optimum Min. melt temperature Max. melt temperature	no 100 3 - 4 ≤0.2 190 180 200	h % °C °C	

Printed: 2025-05-30 Page: 1 of 6

≤0.3 m/s

65 °C

Revised: 2024-12-03 Source: Celanese Materials Database

Screw tangential speed

Mold Temperature Optimum





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Min. mould temperature60 °CMax. mould temperature70 °CHold pressure range60 - 120 MPaBack pressure2 MPa

Characteristics

Processing Injection Moulding, Extrusion

Delivery form Pellets

Additives Release agent

Special characteristics High impact or impact modified, U.V. stabilised or stable to weather

Additional information

Processing Notes Pre-Drying

Drying is not normally required. If material has come in contact with moisture through improper storage or handling or through regrind use, drying to prevent splay and odor problems.

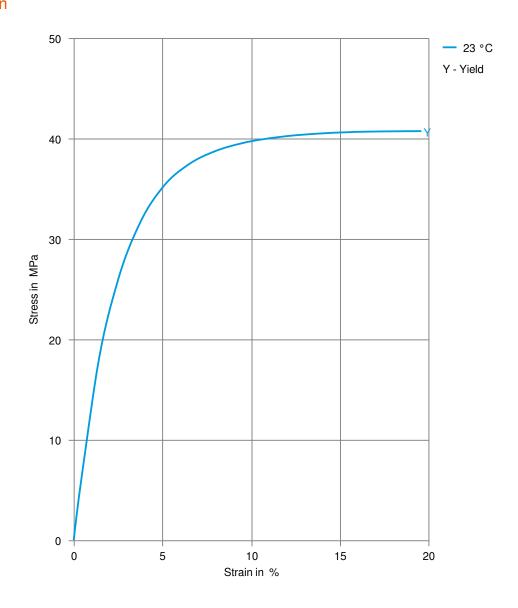
Printed: 2025-05-30 Page: 2 of 6





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Stress-strain



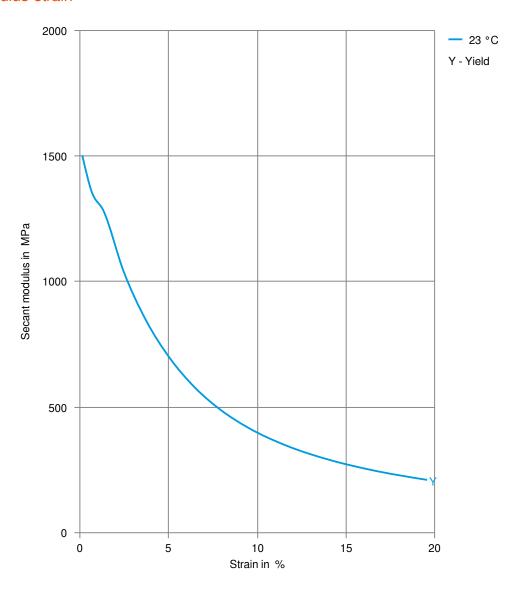
Printed: 2025-05-30 Page: 3 of 6





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Secant modulus-strain



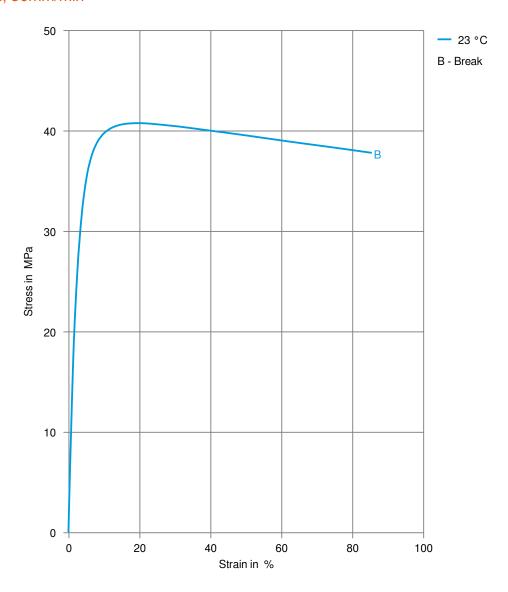
Printed: 2025-05-30 Page: 4 of 6





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Stress-strain, 50mm/min



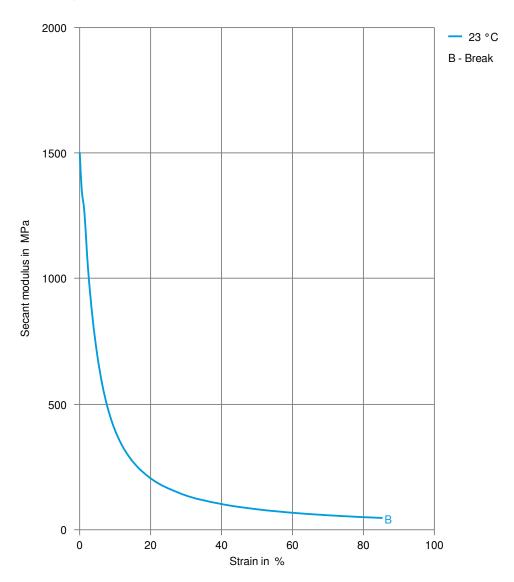
Printed: 2025-05-30 Page: 5 of 6





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Secant modulus-strain, 50mm/min



Printed: 2025-05-30 Page: 6 of 6

Revised: 2024-12-03 Source: Celanese Materials Database

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